



1773

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application for Reissue of	)	
Bunyan <i>et al.</i> , U.S. Patent No. 6,054,198	)	Examiner D. L. Tarazano
	)	
Application No. 09/714,680	)	Group Art Unit 1773
	)	
Filed: November 16, 2000	)	
	)	April 16, 2003
For: Conformal Thermal Interface Material	)	
For Electronic Components	)	Cleveland, Ohio 44124-4141

COMMISSIONER FOR PATENTS  
WASHINGTON, DC 20231

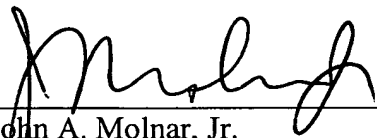
COMMUNICATION

Please find enclosed a copy of Duvall *et al.*, U.S. Patent No. 6,391,442, Phase Change Thermal interface Material," issued May 21, 2002, which Applicants wish to make of record in connection with the above-captioned application.

A continuation of the present reissue application has been filed along with a request for interference under 37 C.F.R. § 1.607.

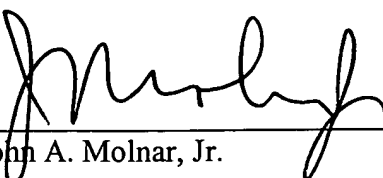
Respectfully submitted,

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GROUP 1700

  
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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited on April 16, 2003, with the United Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231.

  
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John A. Molnar, Jr.